

**Declaration and Power of Attorney  
For Patent Application  
(Sole/Joint)**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I verily believe I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought, on the invention entitled A Rotary Drive Device of a Polishing Device

the specification of which (Check One)

X is attached hereto.

\_\_\_\_\_ was filed on \_\_\_\_\_ as

[ ] Application Serial No. \_\_\_\_\_

[ ] International Application No. PCT/ \_\_\_\_\_

and was amended on \_\_\_\_\_

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

**PRIOR FOREIGN APPLICATION(S)**

			Priority Claimed	
<u>2000-86061</u> <small>(Number)</small>	<u>Japan</u> <small>(Country)</small>	<u>27/03/00</u> <small>(Day/Month/Year Filed)</small>	Yes: <u>X</u>	No: _____
<u>2001-36083</u> <small>(Number)</small>	<u>Japan</u> <small>(Country)</small>	<u>13/02/01</u> <small>(Day/Month/Year Filed)</small>	Yes: <u>X</u>	No: _____
_____ <small>(Number)</small>	_____ <small>(Country)</small>	_____ <small>(Day/Month/Year Filed)</small>	Yes: _____	No: _____

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose

material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

(Application Serial No.)	(Filing Date)	(Status)
(Application Serial No.)	(Filing Date)	(Status)

I or we hereby appoint the following attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and request that all correspondence about the application be addressed to ROTHWELL, FIGG, ERNST & KURZ, P.C., 555 13th Street, N.W., Washington, D.C 20004

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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